

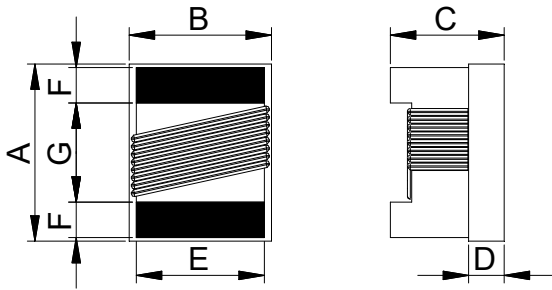
### Features

- \* RoHS Compliant
- \* Ceramic body and wire wound construction provide high SRFs.
- \* These ultra - compact inductors provided exceptional Q values, even at high frequencies.
- \* Their ceramic construction delivers the highest possible SRFs as well as excellent Q values.
- \* The non-magnetic coil form also assures the utmost in thermal stability, predictability and batch consistency.
- \* ECS series is standard parts for RF designers.

### Applications

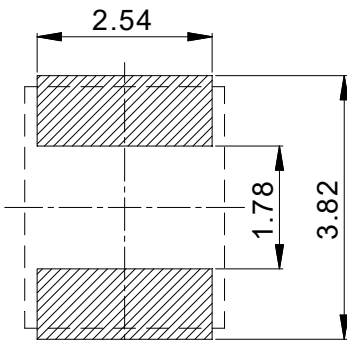
- \* cellular phone, GPS receiver, Base Station, Repeater, Wireless LAN/Mouse/Keyboard/earphone, remote control, security system and other RF modules.

### Appearance and Dimensions

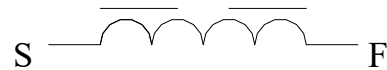


Dimensions(mm)							
Series	A	B	C	D	E	F	G
ECS1210	3.5max.	2.9max.	2.25max.	typ.	typ.	typ.	typ.

### Land Pattern Dimensions



### Circuit Diagram



### Product Identification

ECS 1210 - 1N0 J - S

① ② ③ ④ ⑤

- ① Product Symbol
- ② Dimensions
- ③ Inductance Value (1N0:1.0nH; R10:100nH; 1R0:1000μH; 100:10000μH)
- ④ Inductance Tolerance (S:±0.3; G:±2%; J:±5%; K:±10%; M:±20%)
- ⑤ Internal No

**苏州隆亿电子科技有限公司**

SUZHOU LONGYI ELECTRONIC TECHNOLOGY CO.,LTD.

TEL: +86 512-66322495 FAX: +86 512-68055173

<https://www.lyetec.com> E-mail: [sales@lyetec.com](mailto:sales@lyetec.com)

### Electrical Characteristics

Part No.	Inductance	Tol.	Q min.	Test Frequency	Self-resonant Frequency min.	DC Resistanc max.	Heat Rating Current max.
Unit	nH	%	-	MHz	MHz	Ω	mA
Symbol	L	Tol.	-	-	-	R <sub>DC</sub>	I <sub>RMS</sub>
ECS1210-10NJ-S	10.000	±5	40@300MHz	100	4000	0.08	1000
ECS1210-12NJ-S	12.000	±5	40@300MHz	100	3200	0.08	1000
ECS1210-15NJ-S	15.000	±5	40@300MHz	100	3200	0.20	1000
ECS1210-18NJ-S	18.000	±5	50@300MHz	100	2800	0.10	1000
ECS1210-22NJ-S	22.000	±5	50@300MHz	100	2200	0.10	1000
ECS1210-27NJ-S	27.000	±5	50@300MHz	100	1800	0.11	1000
ECS1210-33NJ-S	33.000	±5	55@300MHz	100	1800	0.11	1000
ECS1210-39NJ-S	39.000	±5	55@300MHz	100	1500	0.12	1000
ECS1210-43NJ-S	43.000	±5	55@300MHz	100	1500	0.12	1000
ECS1210-47NJ-S	47.000	±5	55@300MHz	100	1500	0.13	1000
ECS1210-56NJ-S	56.000	±5	55@300MHz	100	1450	0.14	1000
ECS1210-68NJ-S	68.000	±5	55@300MHz	100	1200	0.15	900.0
ECS1210-82NJ-S	82.000	±5	55@300MHz	100	1000	0.20	900.0
ECS1210-91NJ-S	91.000	±5	60@300MHz	100	1100	0.20	1000
ECS1210-R10J-S	100.00	±5	55@300MHz	100	900.0	0.20	850.0
ECS1210-R12J-S	120.00	±5	60@300MHz	100	800.0	0.25	800.0
ECS1210-R15J-S	150.00	±5	60@300MHz	100	700.0	0.30	750.0
ECS1210-R18J-S	180.00	±5	60@300MHz	50.0	650.0	0.30	700.0
ECS1210-R22J-S	220.00	±5	60@300MHz	50.0	650.0	0.40	770.0
ECS1210-R24J-S	240.00	±5	40@300MHz	50.0	580.0	0.40	630.0
ECS1210-R27J-S	270.00	±5	40@300MHz	50.0	580.0	0.40	630.0
ECS1210-R33J-S	330.00	±5	45@150MHz	50.0	580.0	0.58	590.0
ECS1210-R36J-S	360.00	±5	45@150MHz	50.0	510.0	0.58	530.0
ECS1210-R39J-S	390.00	±5	45@150MHz	50.0	510.0	0.58	530.0
ECS1210-R47J-S	470.00	±5	45@150MHz	50.0	480.0	1.00	490.0
ECS1210-R56J-S	560.00	±5	45@150MHz	25.0	420.0	1.1	460.0

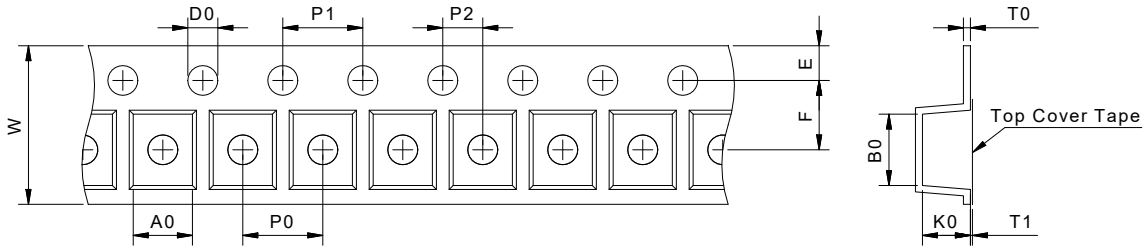
ECS1210-R68J-S	680.00	±5	45@150MHz	25.0	400.0	1.20	430.0
ECS1210-R82J-S	820.00	±5	45@150MHz	25.0	370.0	2.00	400.0
ECS1210-1R0J-S	1000.0	±5	45@150MHz	25.0	340.0	1.85	320.0
ECS1210-1R2J-S	1200.0	±5	45@150MHz	25.0	220.0	2.30	300.0
ECS1210-1R5J-S	1500.0	±5	20@50MHz	7.90	160.0	2.70	310.0
ECS1210-1R8J-S	1800.0	±5	30@50MHz	7.90	160.0	3.50	310.0
ECS1210-2R2J-S	2200.0	±5	25@50MHz	7.90	130.0	2.41	310.0
ECS1210-2R7J-S	2700.0	±5	25@50MHz	7.90	110.0	3.50	300.0
ECS1210-3R0J-S	3000.0	±5	20@25MHz	7.90	110.0	3.50	300.0
ECS1210-3R3J-S	3300.0	±5	20@25MHz	7.90	60.00	3.60	290.0
ECS1210-3R9J-S	3900.0	±5	20@25MHz	7.90	60.00	4.00	290.0
ECS1210-4R7J-S	4700.0	±5	20@25MHz	7.90	60.00	5.00	280.0
ECS1210-5R2J-S	5200.0	±5	15@25MHz	7.90	50.00	6.00	250.0
ECS1210-5R6J-S	5600.0	±5	15@25MHz	7.90	50.00	6.00	250.0
ECS1210-6R8J-S	6800.0	±5	15@7.9MHz	7.90	40.00	9.00	230.0
ECS1210-7R5J-S	7500.0	±5	20@7.9MHz	7.90	50.00	9.50	170.0
ECS1210-8R2J-S	8200.0	±5	20@7.9MHz	7.90	50.00	9.50	170.0
ECS1210-8R6J-S	8600.0	±5	15@7.9MHz	7.90	40.00	9.00	200.0
ECS1210-100J-S	10000	±5	15@7.9MHz	7.90	30.00	10.0	150.0

### Remark:

- ※1: All test data is referenced to 20°C ambient.
- ※2: Q: The power periodically exchanged between an inductor and a power source in an AC circuit.
- ※3: Self-resonant Frequency: The self-resonant frequency is the high-frequency critical point of practical passive components.
- ※4: DC Resistance: DC resistance at 20°C.
- ※5: Heat Rating Current: DC current that causes the temperature rise ( $\Delta T$ ) from 20°C ambient,  
for max. Value,  $\Delta T < 40^\circ\text{C}$ .
- ※6: Specifications subject to change without notice. Please check our website for latest information.

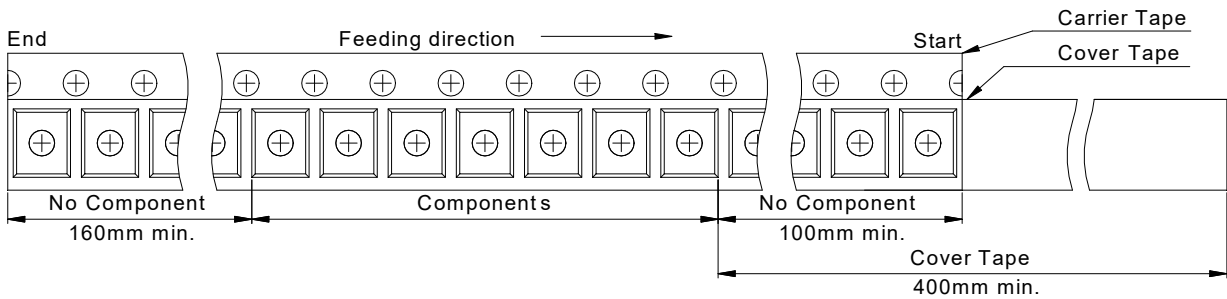
### Packing specification

Carrier tape dimensions (mm)



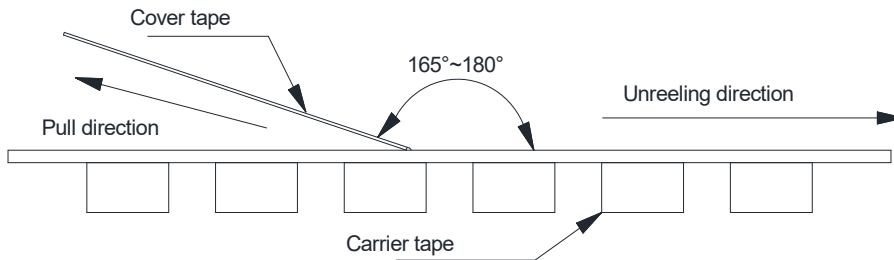
ITEM	W	P0	E	F	T0	T1	A0	B0	K0	D0	P1	P2
Size(mm)	8.0	4.0	1.75	3.50	0.35	0.10	2.96	3.6	2.40	1.50	4.00	2.00
Tolerance	±0.30	±0.10	±0.10	±0.10	ref.	max.	typ.	typ.	typ.	±0.10	±0.10	±0.10

Taping dimensions (mm)

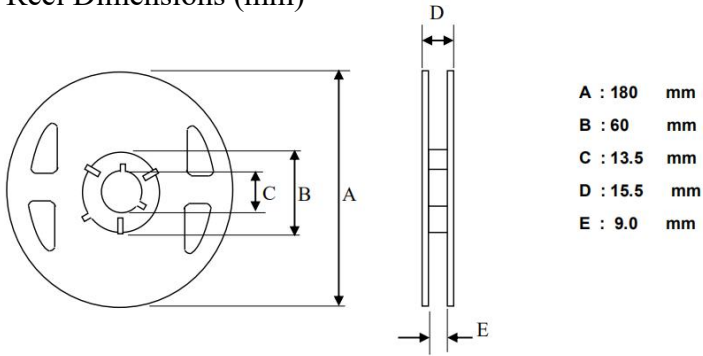


Cover Tape Peel Off Condition

Cover tape peel force shall be 10g to 130g.



### Reel Dimensions (mm)



### Packing Quantity

Product Series	Quantity/Reel	Inner Carton Quantity	Outer Carton Quantity
ECS1210	2000pcs	(2000X6)=12000pcs	(12000X3)=36000pcs



### Recommended Soldering Conditions

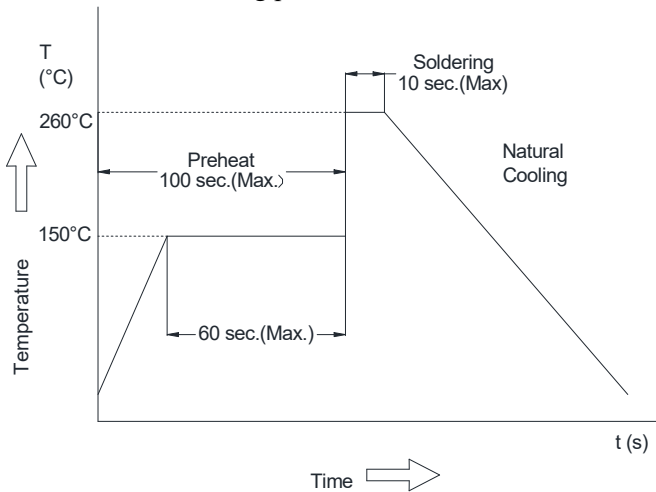
Product can be applied to flow and reflow soldering.

(1) Flux, Solder

- ① Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).
- ② Use Sn solder.

(2) Flow soldering conditions

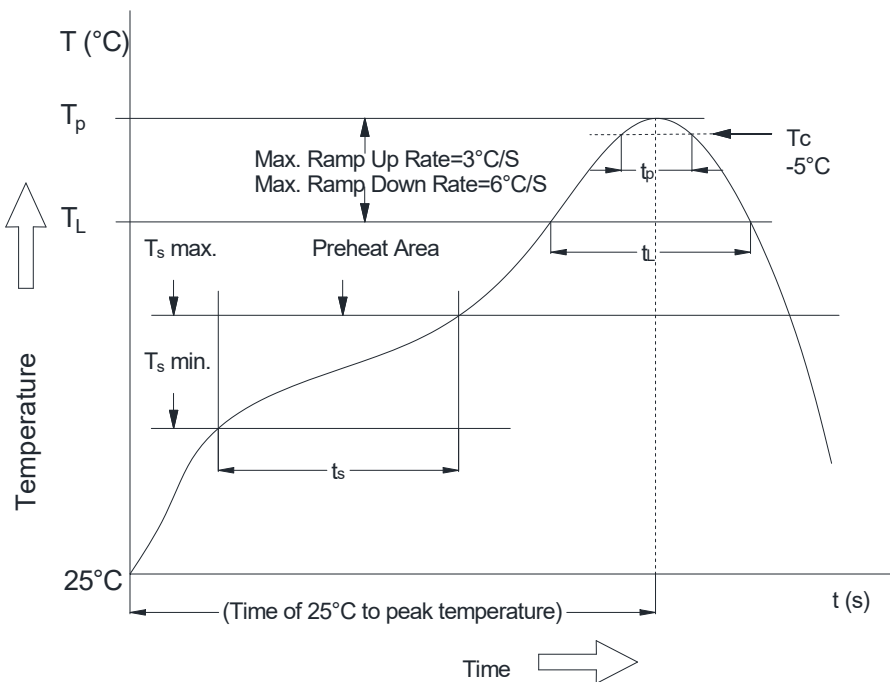
- ① Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100°C max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.
- ② Standard soldering profile.



<b>Pre-heating</b>	150°C, 1 minute min
<b>Peak</b>	260°C, 10 seconds max

(3) Reflow soldering conditions

Classification Reflow Profile for SMT components:



Classification Reflow Soldering Profile:

Profile Feature		Lead-Free Assembly
Average Ramp-Up Rate (Ts max. to Tp)		3°C/second max.
Preheat	– Temperature Min (Ts min.)	150°C
	– Temperature Max (Ts max.)	200°C
	– Time (Ts min to Ts max.)	60-120 seconds
Time maintained above	– Temperature (TL)	217°C
	– Time (tL)	60-150 seconds
Peak/Classification Temperature (Tp)		see table below
Peak/Classification Time (Tp)		3-4 seconds
Time within 5 °C of actual Peak Temperature (tp)		20-30 seconds
Ramp-Down Rate		6°C/second max.
Time 25 °C to Peak Temperature		8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

2: Refer to IPC/ JEDEC J-STD-020E

Package Classification Reflow Temperature:

Properties	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
PB-Free Assembly   Package Thickness < 1.6 mm	260°C	260°C	260°C
PB-Free Assembly   Package Thickness 1.6mm-2.5 mm	260°C	250°C	245°C
PB-Free Assembly   Package Thickness ≥2.5 mm	250°C	245°C	245°C

Refer to IPC/ JEDEC J-STD-020E

(4) The method on Re-work with using the iron:

The following conditions must be strictly followed when using a soldering iron

Pre-heating	150°C, 1 minute
Tip temperature	280°C max
Soldering iron output	20w max
End of soldering iron	φ1mm max
Soldering time	3 seconds max

## Products Storage

(1) Storage period

Products which inspected in LYEC over 12 months ago should be examined and used, which can be confirmed with inspection No. marked on the container. Solderability should be checked if this period is exceeded.

(2) Storage conditions

Products should be storage in the warehouse on the following conditions:

Temperature: Less than 40°C

Humidity : Less than 75% relative and humidity

No rapid change on temperature and humidity

- (3) Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- (4) Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
- (5) Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- (6) Products should be storage under the airtight packaged condition.